



## EC Declaration of Conformity (DoC)

We

Texas Instruments Incorporated  
12500 TI Boulevard  
Dallas, Texas 75243 USA

Declare that the DoC is issued under our sole responsibility and belongs to the following product(s):

<b>Product Type:</b>	Evaluation Module
<b>Model Number(s):</b>	OPT3001EVM
<b>Serial/Batch Numbers:</b>	

The object of the declaration described above is in conformity with the relevant Union harmonization legislation:

**Electromagnetic Compatibility Directive 2014/30/EU** of 29 March 2014.

The following harmonized standards and technical specifications have been applied:

EN 61326-1:2013	Electrical equipment for measurement, control and laboratory use – EMC requirements – Part 1: General requirements
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**Notified Body:**

<b>Notified Body:</b>	UL Verification Services Inc.
<b>Notified Body Number</b>	0984
<b>Reference number of the certificate of notified body</b>	AN17C11025-1

**Technical Compliance File Held by:**

Texas Instruments Incorporated  
12500 TI Boulevard  
Dallas, Texas 75243 USA

**Signed for and on behalf of Texas Instruments Incorporated**

Name:	Mark Mason, Manager, Customer Quality Engineering
Address:	12500 TI Blvd, MS J2-20, Dallas, Texas 75243

Dallas, Texas

5/29/2018

Place of issue

Date of issue

Signature of Authorized Person

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